

1.3MHz 1.5A, Synchronous Step-Down Regulator

General Description

EML3417 is designed with high efficiency step down DC/DC converter for portable devices applications. It features with extreme low quiescent current with no load which is the best fit for extending battery life during the standby mode. The device operates from 2.5V to 5.5V input voltage and up to 1.5A output current capability. High 1.3MHz internal frequency makes small surface mount inductors and capacitors possible and reduces overall PCB board space. Further, build-in synchronous switch makes external Schottky diode is no longer needed and efficiency is improved. EML3417 is designed base on pulse width modulation (PWM) for low output voltage ripple and fixed frequency noise, low dropout mode provides 100% duty cycle operation. Low reference voltage is designed for achieving regulated output down to 0.6V.

The device is available in an adjustable version. The EML3417 is available in DFN-6 package.

Typical Application (adjustable)

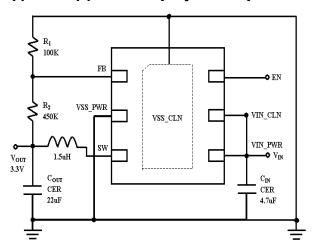


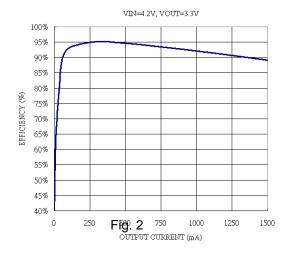
Fig. 1

Features

- Achieve 95% efficiency
- Input Voltage: 2.5V to 5.5V
- Output Current up to 1.5A
- Reference voltage 0.6V
- Quiescent Current 240µ A with No Switching
- Internal switching frequency 1.3MHz
- No Schottky Diode needed
- Low Dropout Operation: 100% Duty Cycle
- Shutdown current < 1µ A
- Excellent Line and Load Transient Response
- Over-current and Over-temperature Protection

Applications

- Blue-Tooth devices
- Cellular and Smart Phones
- Personal multi-media Player (PMP)
- Wireless networking
- Digital Still Cameras
- Portable applications



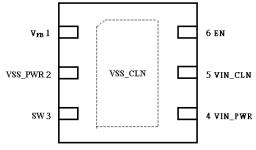
Order, Mark & Packing Information

Package	Vout	Product ID	Marking	Packing
TDFN-6	adjustable	EML3417-00FF06NRR	6 5 4 ESMT EML3417 Tracking Code 1 1 2 3	5K units Tape & Reel

Publication Date: Oct. 2013 Revision: 5.4 1/15



Package configuration



DFN-6, Adjustable

EML3417-00FF06NRR

00 Adjustable TDFN-6 Package
RoHS & Halogen free
Rating: -40 to 85°C FF06 NRR

Package in Tape & Reel

Pin Functions

Pin #	Pin Name	Function
1	V _{FB} (Adjustable)	Feedback Pin. Receives the feedback voltage from an external resistive divider across the output.
'	V_{OUT} (Fixed voltage)	Output Voltage Pin. An internal resistive divider divides the output voltage down for comparison to the internal reference voltage.
2	VSS_PWR	Power Ground Pin.
3	SW	Switch Pin. Must be connected to Inductor. This pin connects to the drains of the internal main and synchronous power MOSFET switches.
4	VIN_PWR	Power Input Pin. Must be closely decoupled to GND pin with a 4.7µF or greater ceramic capacitor.
5	VIN_CLN	Analog Input Pin. Must be closely decoupled to GND pin with a 4.7µF or greater ceramic capacitor.
6	EN	Enable Pin. Minimum 1.2V to enable the device. Maximum 0.4V to shut down the device. Do not leave this pin floating and enable the chip after Vin is in the input voltage range.
Exposed pad	VSS_CLN	Analog Ground Pin.



Absolute Maximum Ratings

Devices are subjected to failure if they stay above absolute maximum ratings.

Input Voltage 0.3V to 6V	Operating Temperature Range
EN, V_{FB} Voltages0.3V to V_{IN}	Junction Temperature (Notes 1, 3) 125°C
SW Voltage0.3V to $(V_{IN} + 0.3V)$	Storage Temperature Range 65°C to 150°C
PMOS Switch Source Current (DC) 2A	Lead Temperature (Soldering, 10 sec) 260°C
NMOS Switch Sink Current (DC) 2A	ESD Susceptibility HBM 2KV
Peak Switch Sink and Source Current 3.5A	MM 200V

Thermal data

Thermal resistance	Parameter	Value
θ JA	Junction-ambient	55°C/W
θ JC	Junction-case	10°C/W

Electrical Characteristics

The lacktriangle denotes specifications which apply over the full operating temperature range, otherwise specifications are $T_A = 25^{\circ}C$. V_{IN} = 5V unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Units
I _{VFB}	Feedback Current					±100	nA
\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		T _A = 25°C		0.588	0.6	0.612	
V FB	V _{FB} Regulated Feedback Voltage	-40°C ≤ T _A ≤ 85°C	•	0.585	0.6	0.615	V
Vout %	Output Voltage Accuracy		•	-3		3	%
Δ V_{FB}	Reference Voltage Line Regulation	V _{IN} = 2.5V to 5.5V	•			0.4	%/V
A \/		$\Delta V_{OVL} = V_{OVL} - V_{FB}$, EML3417		20	50	80	mV
Δ V _{OVL}	Output Over-voltage Lockout	$\Delta V_{OVL} = V_{OVL} - V_{OUT}$, EML3417-Fixed		2.5	7.8	13	%
Δ V _{OUT}	Output Voltage Line Regulation	V _{IN} = 2.5V to 5.5V	•			0.4	%/V
	2	$V_{IN} = 3V$, $V_{FB} = 0.5V$ or $V_{OUT} = 90\%$,			2.4		,
l _{PK}	Peak Inductor Current	Duty Cycle < 35%		2.4			Α
$V_{LOADREG}$	Output Voltage Load Regulation	I _{OUT} =10mA to 1.5A			0.2		%/A
	Quiescent Current (Note 2)	$V_{FB} = 0.5V \text{ or } V_{OUT} = 90\%$			240	340	μΑ
Is	Shutdown	$V_{EN} = 0V$, $V_{IN} = 4.2V$			0.1	1	μА
fosc	Oscillator Frequency	$V_{FB} = 0.6V \text{ or } V_{OUT} = 100\%$	•	1.04	1.30	1.56	MHz
R _{PFET}	R DS(ON) of PMOS	I _{sw} = 750mA			0.18		Ω
R _{NFET}	R DS(ON) OF NMOS	$I_{SW} = -750 \text{mA}$			0.16		Ω
I _{LSW}	SW Leakage	$V_{EN} = 0V$, $V_{SW} = 0V$ or $5V$, $V_{IN} = 5V$				±1	μА
	Enable Threshold		•	1.2			٧
V _{EN}	Shutdown Threshold		•			0.4	٧
I _{EN}	EN Leakage Current		•			±1	μА

Note 1: T_A is a function of the ambient temperature T_A and power dissipation P_D ($T_A = T_A + (P_D)(55^{\circ}C/W)$)

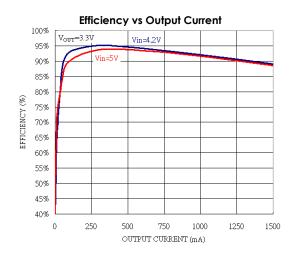
Note 2: Dynamic quiescent current is higher due to the gate charge being delivered at the switching frequency.

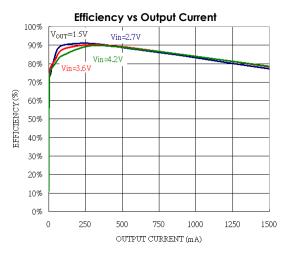
Note 3: This IC is build-in over-temperature protection to avoid damage from overload conditions.

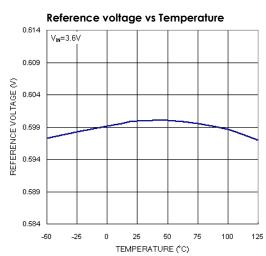
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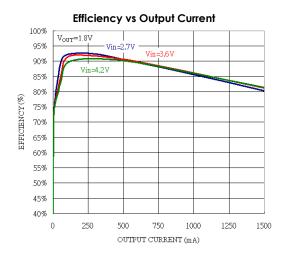


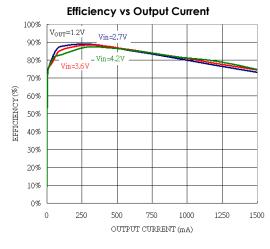
Typical Performance Characteristics

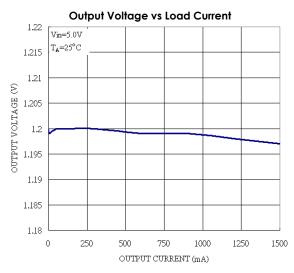




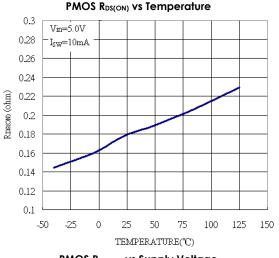


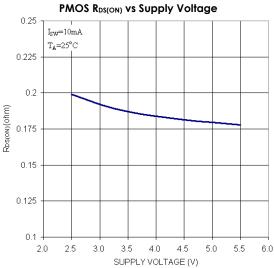


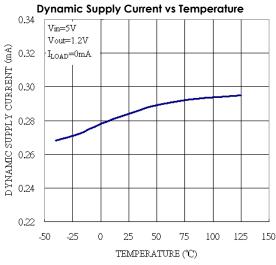


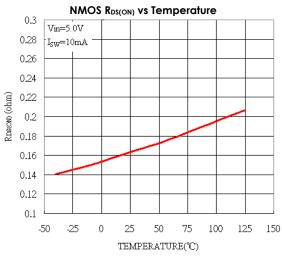


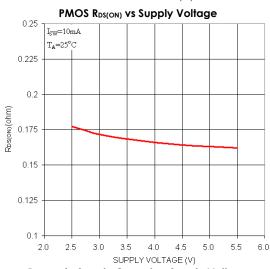


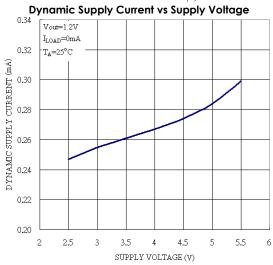




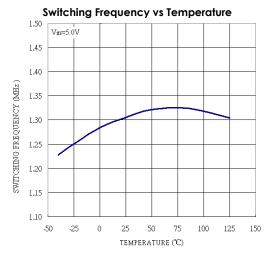


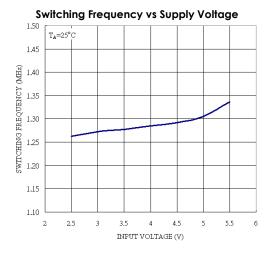


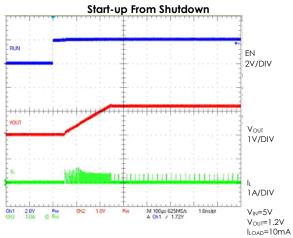


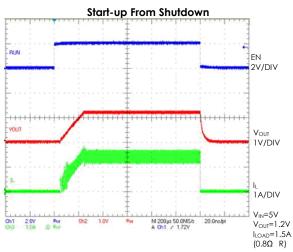


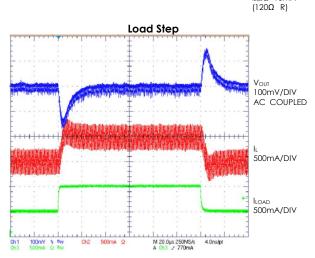


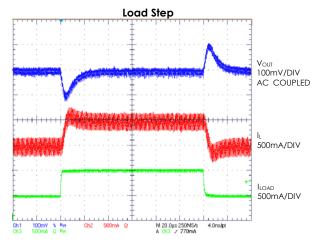










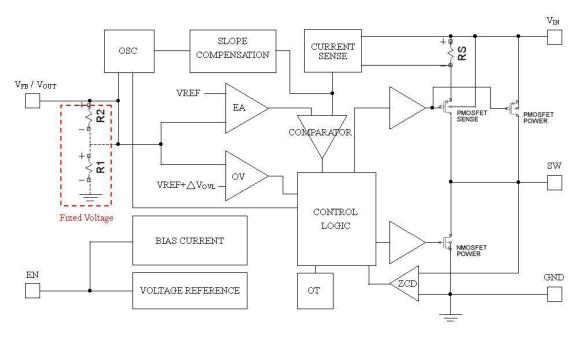


 $V_{\text{IN}}\!\!=\!5.0\text{V},\,V_{\text{OUT}}\!\!=\!2.5\text{V},\,I_{\text{LOAD}}\!\!=\!\!500\text{mA}$ to 1 A

 $V_{\text{IN}}\!\!=\!3.3V,\,V_{\text{OUT}}\!\!=\!1.5V,\,I_{\text{LOAD}}\!\!=\!500\text{mA}$ to 1 A



Functional Block Diagram

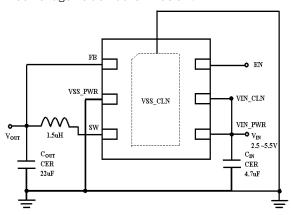




Applications

The typical application circuit of adjustable version is shown in Fig. 1.

Fixed voltage version is shown below:



Inductor Selection

Basically, inductor ripple current and core saturation current are two factors considered to decide the Inductor value.

$$\Delta I_{L} = \frac{1}{f \cdot L} V_{OUT} \left(1 - \frac{V_{OUT}}{V_{IN}} \right)$$
 Eq. 1

The Eq. 1 shows the inductor ripple current is a function of frequency, inductance, Vin and Vout. It is recommended to set ripple current to 40% of max. load current. A low ESR inductor is preferred.

CIN and COUT Selection

A low ESR input capacitor can prevent large voltage transients at V_{IN} . The RMS current of input capacitor is required larger than I_{RMS} calculated by:

$$I_{\text{RMS}} \stackrel{\cong}{=} I_{\text{OMAX}} \frac{\sqrt{V_{\text{OUT}} \left(V_{\text{IN}} - V_{\text{OUT}}\right)}}{V_{\text{IN}}} \hspace{0.5cm} \text{Eq. 2}$$

ESR is an important parameter to select C_{OUT} . The output ripple V_{OUT} is determined by:

$$\Delta V_{OUT} \cong \Delta I_{L} \left(ESR + \frac{1}{8 \cdot f \cdot C_{OUT}} \right)$$
 Eq. 3

Higher values, lower cost ceramic capacitors are now available in smaller sizes. These ceramic capacitors have high ripple currents, high voltage ratings and low ESR that make them ideal for switching regulator applications. Optimize very low output ripple and small circuit size is doable from Cout selection since Cout does not affect the internal control loop stability. It is recommended to use the X5R or X7R which have the best temperature and voltage characteristics of all the ceramics for a given value and size.

Output Voltage (EML3417 adjustable)

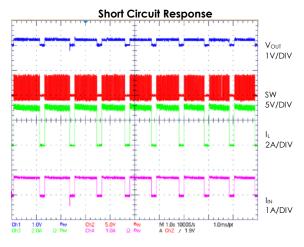
In the adjustable version, the output voltage can be determined by:

$$V_{OUT} = 0.6 V \left(1 + \frac{R_2}{R_1} \right)$$
 Eq. 4

Short Circuit Behavior

EML3417 has over-current and over-temperature protection.

Over-current protection cycle by cycle limits P-driver FET current to prevent inductor current from losing control. Over-temperature protection function turns off driver FETs when junction temperature is high and recovers to normal operation after it is cool enough. When EML3417 is used to transfer Vin=5V to Vout=1.2V, shorting Vout to ground makes over-current and over- temperature protection active. The waveform is shown as the following diagram.



Thermal Considerations

Although thermal shutdown is build-in in EML3417 that protect the device from thermal damage, the total power dissipation that EML3417 can sustain should be base on the package thermal capability. The formula to ensure the safe operation is shown in Note 1.

To avoid the EML3417 from exceeding the maximum junction temperature, the user will need to do some thermal analysis.

Guidelines for PCB Layout

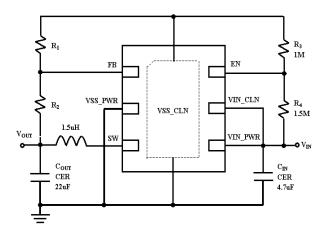
To ensure proper operation of the EML3417, please note the following PCB layout guidelines:

- 1. The GND trace, the SW trace and the V_{IN} trace should be kept short, direct and wide.
- 2. V_{FB} pin must be connected directly to the feedback resistors. Resistive divider R_1/R_2 must be connected and parallel to the output capacitor C_{OUT} .
- 3. The Input capacitor C_{IN} must be connected to pin V_{IN} as closely as possible.
- 4. Keep SW node away from the sensitive V_{FB} node since this node is with high frequency and voltage swing.
- 5. Keep the (–) plates of C_{IN} and C_{OUT} as close as possible.
- 6. Connect all analog grounds to a common node and connect the common node to power ground through an independent path.

Self-Enable Application

A self-enable function could be used when EML3417 is connected as the following diagram:

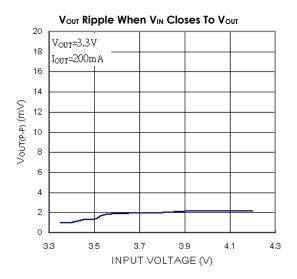




The resistor ratio R3:R4=1:1.5 is recommended.

Output Voltage Ripple When V_{IN} Closes To V_{OUT}

EML3417 goes into LDO mode when input voltage closes to output voltage. The transition from PWM mode to LDO mode is smooth. Bottom diagram shows the relationship of output voltage ripple versus input voltage when output voltage is 3.3V and EML3417 provides 200mA load current.



Design Example

Assume the EML3417 is used in a single lithium-ion battery-powered application. The $V_{\rm IN}$ range will be about 2.7V to 4.2V. Output voltage is 1.8V.

With this information we can calculate L using equation:

$$L = \frac{1}{f \cdot \Delta I_{L}} V_{OUT} \left(1 - \frac{V_{OUT}}{V_{IN}} \right)$$

Substituting V_{OUT} = 1.8V, V_{IN} = 4.2V, ΔI_{L} = 600mA and f = 1.3MHz in eq. 1 gives:

$$L = \frac{1.8V}{1.3MHz \cdot 600mA} \left(1 - \frac{1.8V}{4.2V} \right) = 1.32uH$$

A 1.5 μ H inductor could be chose with this application. A greater inductor with less equivalent series resistance makes best efficiency. $C_{\rm IN}$ will require an RMS current rating of at least $l_{\rm IOAD[MAX]}/2$ and low ESR. In most cases, a ceramic capacitor will satisfy this requirement.

Recommended Components

Supplier	Inductance (uH)	I _{sat} (A)	DCR_{max} (m Ω)	Dimensions (mm)	Part Number
Coilcraft	1.5	14	13	12.3 x 12.3 x 6	MSS1260-152NLB

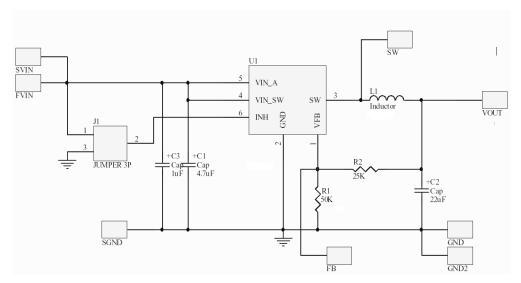
Supplier	Capacitance (uF)	Package	Part Number
YAGEO	4.7	0805	CC0805KKX5R6BB475
TAIYO YUDEN	22	1812	EMK432BJ226KM-T

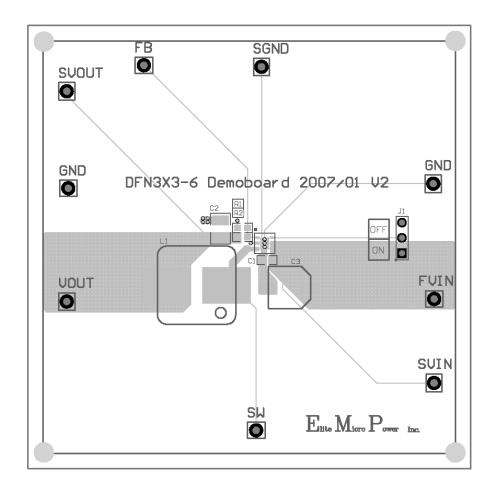
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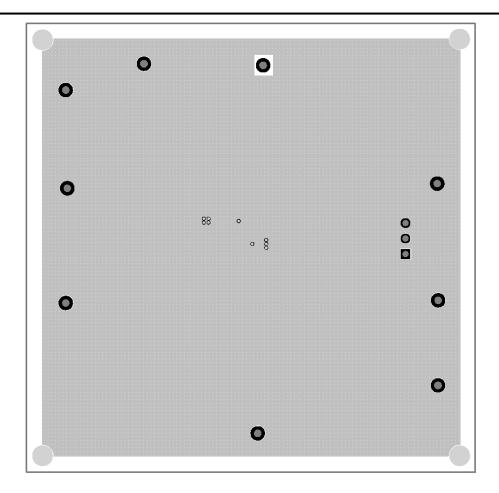
Application (Continued)

Typical schematic for PCB layout





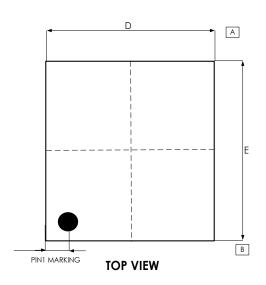


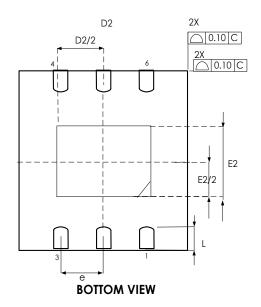


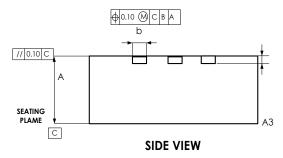


Package Information

TDFN-6







	COMMON						
SYMBOL	DIMENSIONS MILLIMETER			DIMENSIONS INCH			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.70	0.75	0.80	0.028	0.030	0.031	
А3	0.203 REF				0.008 REF		
р	0.25	0.30	0.35	0.010	0.012	0.014	
D		3.00 BSC		0.118 BSC			
D2	2.20	2.30	2.35	0.087	0.091	0.093	
Е		3.00 BSC			0.118 BSC		
E2	1.40	1.50	1.55	0.055	0.059	0.061	
е	0.95 BSC				0.037 BSC		
Ĺ	0.25	0.35	0.45	0.010	0.014	0.018	



Old Order, Mark & Packing Information

Package	Vout	Product ID	Marking	Packing
TDFN-6	adjustable	EML3417-00FF06NRR	6 5 4 EMP EML3417 Tracking Code PINI DOT 1 2 3	5K units Tape & Reel



Revision History

Revision	Date	Description
5.0	2009.06.05	EMP transferred from version 4.4
5.1	2010.06.02	To revise circuitry
5.2	2010.09.30	Package dimension update
5.3	2011.01.28	Revise electrical characteristics (VEN)
5.4	2013.11.01	Modify marking



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